



OKI Semiconductor

PEDR26V51203L-02-06 Issue Date: Jul. 9, 2004

MR26V51203L

Preliminary

 $32M-Word \times 16$ -Bit or $64M-Word \times 8$ -Bit P2ROM

FEATURES

 \cdot 33,554,432-word \times 16-bit/67,108,864-word \times 8-bit electrically switchable configuration

- · 3.0 V to 3.6 V power supply
- · Access time 100 ns MAX (MR26V51203L-xxxMB) 120 ns MAX (MR26V51203L-xxxMBE)
- · Operating current 40 mA MAX(5MHz)
- · Standby current 200 µA MAX
- · Input/Output TTL compatible
- · Three-state output

PACKAGES

· MR26V51203L-xxxMB, MR26V51203L-xxxMBE 70-pin plastic SSOP (P-SSOP70-500-0.80-K-MC)

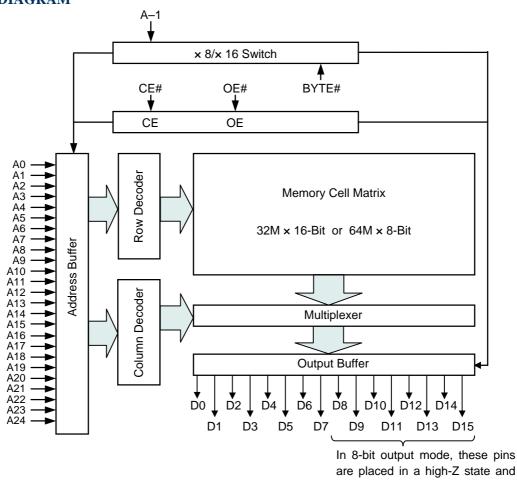
P2ROM ADVANCED TECHNOLOGY

P2ROM stands for Production Programmed ROM. This exclusive Oki technology utilizes factory test equipment for programming the customers code into the P2ROM prior to final production testing. Advancements in this technology allows production costs to be equivalent to MASKROM and has many advantages and added benefits over the other non-volatile technologies, which include the following:

- Short lead time, since the P2ROM is programmed at the final stage of the production process, a large P2ROM inventory "bank system" of un-programmed packaged products are maintained to provide an aggressive lead-time and minimize liability as a custom product.
- No mask charge, since P2ROMs do not utilize a custom mask for storing customer code, no mask charges apply.
- No additional programming charge, unlike Flash and OTP that require additional programming and handling costs, the P2ROM already has the code loaded at the factory with minimal effect on the production throughput. The cost is included in the unit price.
- · Custom Marking is available at no additional charge.

PIN CONFIGURATION (TOP VIEW) A11 70 CE# A10 69 A12 A9 68 A13 4 Α8 A14 Α7 5 66 A15 6 7 A6 65 Vcc A5 64 A16 A4 8 63 A17 АЗ 62 A18 10 A2 61 A19 Α1 60 A20 A23 12 59 A21 NC 13 58 NC NC 14 57 NC 56 NC NC NC 16 55 NC NC 17 NC GND 18 70SSOP 53 GND NC 19 52 NC 20 51 NC NC NC 50 NC NC 22 49 NC 48 NC NC 23 24 25 BYTE# 47 A22 46 A24 Α0 D0 26 D8 27 45 OE# 44 D15/A-1 D1 28 43 D7 D9 29 42 D14 30 41 D6 Vcc D2 31 40 D13 39 D5 D10 32 D3 33 38 D12 D11 37 D4 36 Vcc GND 35

BLOCK DIAGRAM



are placed in a high-Z state and pin D15 functions as the A-1 address pin.

PIN DESCRIPTIONS

Pin name	Functions			
D15 / A-1	Data output / Address input			
A0 to A24	Address inputs			
D0 to D14	Data outputs			
CE#	Chip enable input			
OE#	Output enable input			
BYTE#	Word / Byte select input			
V _{CC}	Power supply voltage			
V _{SS}	Ground			

FUNCTION TABLE

Mode	CE#	OE#	BYTE#	V _{CC}	D0 to D7	D8 to D14	D15/A-1
Read (16-Bit)	L	L	Н			D _{OUT}	
Read (8-Bit)	L	L	L	201/	D _{OUT}	Hi–Z	L/H
0 (() 1			Н	3.0 V			
Output disable	L	Н	L	to 3.6 V		*	
Standby	ы		Н	3.0 V	11: 7		
	H *	*	L			Hi–Z	*

^{*:} Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Та		0 to 70	°C
Storage temperature	Tstg	_	-55 to 125	°C
Input voltage	Vı		-0.5 to V _{CC} +0.5	V
Output voltage	Vo	relative to V _{SS}	-0.5 to V _{CC} +0.5	V
Power supply voltage	V _{CC}		–0.5 to 5	V
Power dissipation per package	P _D	Ta = 25°C	1.0	W
Output short circuit current	los	_	10	mA

RECOMMENDED OPERATING CONDITIONS

 $(Ta = 0 \text{ to } 70^{\circ}C)$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
V _{CC} power supply voltage	V _{CC}		3.0	_	3.6	V
Input "H" level	V _{IH}	$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$	2.2	_	V _{CC} +0.5*	V
Input "L" level	V _{IL}		-0.5**	_	0.6	V

Voltage is relative to V_{SS} .

- * : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.
- **: -1.5V(Min.) when pulse width of undershoot is less than 10ns.

PIN CAPACITANCE

 $(V_{CC} = 3.3 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}, \text{ f} = 1 \text{ MHz})$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	C _{IN1}	V ₁ = 0 V	_	_	16	
BYTE#	C _{IN2}	V ₁ = 0 V	_	_	400	pF
Output	C _{OUT}	$V_O = 0 V$	_	_	20	

ELECTRICAL CHARACTERISTICS

DC Characteristics

 $(Ta = 0 \text{ to } 70^{\circ}C)$

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input leakage current	ILI	$V_I = 0$ to V_{CC}			10	μΑ
Output leakage current	I _{LO}	$V_O = 0$ to V_{CC}	_	_	10	μА
V _{CC} power supply current	I _{ccsc}	CE# = V _{CC}	_	_	200	μА
(Standby)	Iccst	CE# = V _{IH}	_	_	2	mA
V _{CC} power supply current		CE# = V _{IL} , OE# = V _{IH}			40	mA
(Read)	I _{CCA}	f=5MHz			40	MA
Input "H" level	V _{IH}	_	2.2	1	V _{CC} +0.5*	V
Input "L" level	V _{IL}	_	-0.5**	_	0.6	V
Output "H" level	V _{OH}	$I_{OH} = -1 \text{ mA}$	2.4	_	_	V
Output "L" level	V _{OL}	$I_{OL} = 2 \text{ mA}$	_	_	0.4	V

Voltage is relative to V_{SS} .

- * : Vcc+1.5V(Max.) when pulse width of overshoot is less than 10ns.
- **: -1.5V(Min.) when pulse width of undershoot is less than 10ns.

AC Characteristics

 $(V_{CC} = 3.0 \text{ to } 3.6 \text{ V}, Ta = 0 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t _C	_	100* 120**	_	ns
Address access time	t _{ACC}	CE# = OE# = V _{IL}	_	100* 120**	ns
CE# access time	t _{CE}	OE# = V _{IL}		100* 120**	ns
OE# access time	t _{OE}	CE# = V _{IL}		30	ns
Output disable time	t _{CHZ}	OE# = V _{IL}	0	20	ns
Output disable liffle	t _{OHZ}	CE# = V _{IL}	0	20	ns
Output hold time	t _{OH}	CE# = OE# = V _{IL}	0	_	ns

- * : MR26V51203L-xxxMB
- **: MR26V51203L-xxxMBE

Measurement conditions

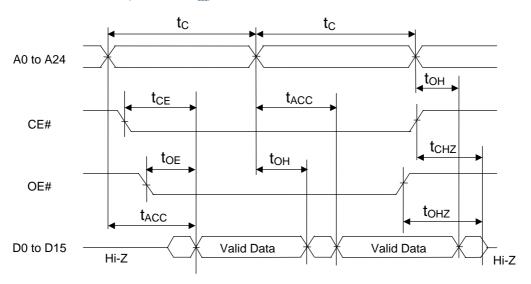
Input signal level ------0 V/3 V Input timing reference level------1/2Vcc Output load ------50 pF Output timing reference level ------1/2Vcc

Output load

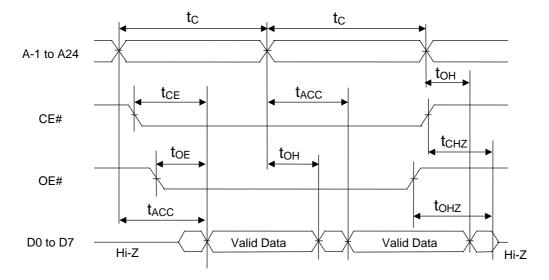


TIMING CHART (READ CYCLE)

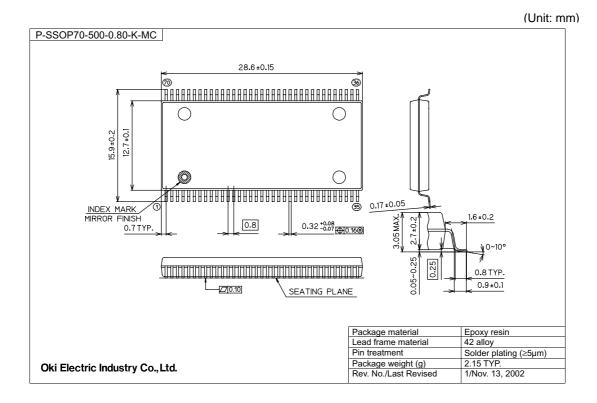
16-Bit Read Mode (BYTE# = V_{IH})



8-Bit Read Mode (BYTE# = V_{IL})



PACKAGE DIMENSIONS



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage.

Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

REVISION HISTORY

Document		Page			
No.	Date	Previous Edition	Current Edition	Description	
PEDR26V51203L-02-01	Mar. 2003	-	_	Preliminary edition 1	
PEDR26V51203L-02-02	Apr. 2003	1	1	Change operating current to 40mA from 70mA, standby current to 20µA from 10µA.	
PEDR26V51203L-02-03	Jun. 2003	1	1, 7	Added MR26V51203L-xxxMB.	
FEDR20V31203L-02-03			2 to 5	Added further information descriptions.	
PEDR26V51203L-02-04	Apr. 1, 2004	1,6	1	Deleted MR26V51203L-xxxTM.	
FEDR20V31203L-02-04	Арг. 1, 2004	1,4	1,,4	Added MR26V51203L-xxxMBE.	
PEDR26V51203L-02-05	Jun. 8, 2004	1, 4	1, 4	Changed I _{LI} , I _{LO} , I _{CCSC} and I _{CCST} .	
PEDR26V51203L-02-06	Jul. 9, 2004	3	3	Add P _D condition and I _{OS} = 10mA	

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